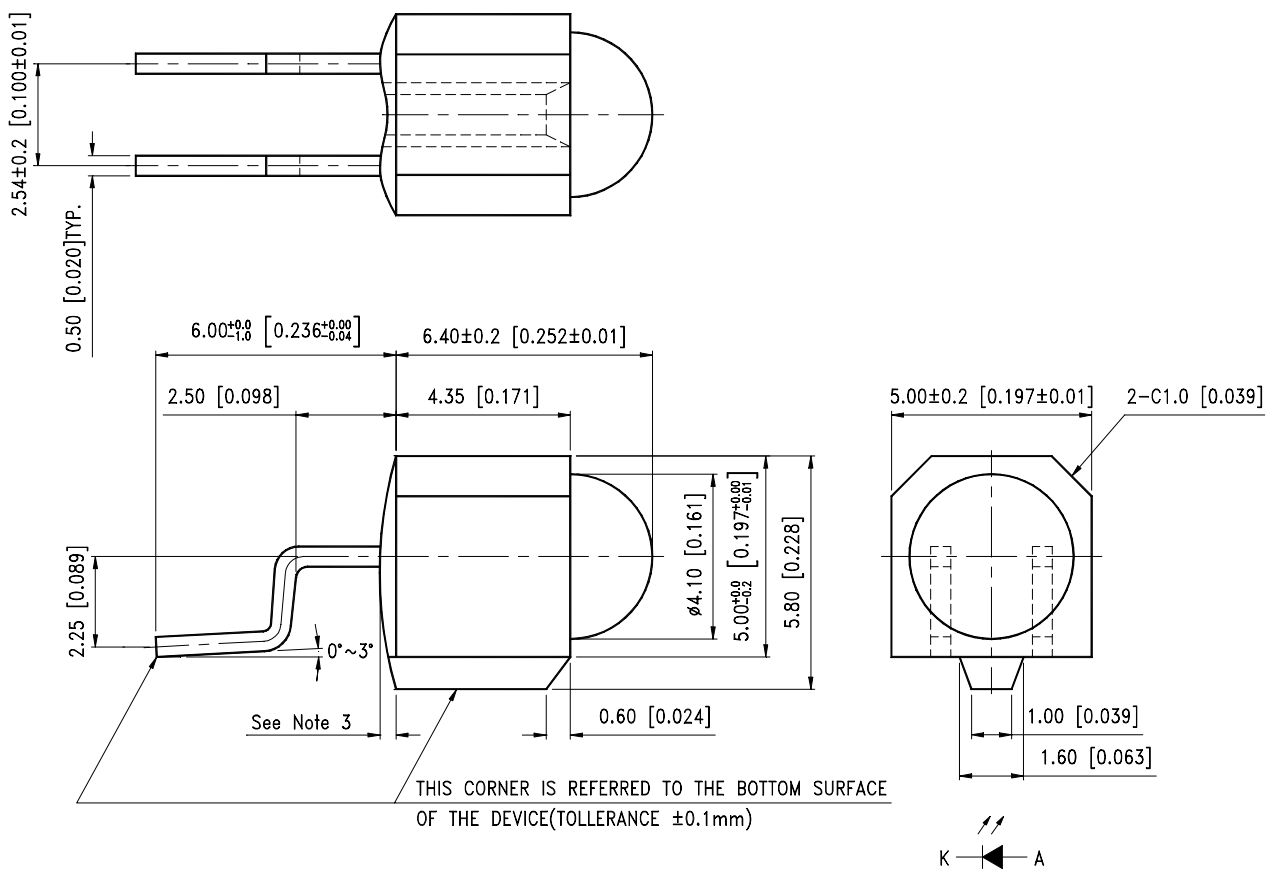


FEATURES

- * HIGH SPEED
- * HIGH POWER
- * AVAILABLE FOR PULSE OPERATING
- * BLUE TRANSPARENT COLOR PACKAGE

PACKAGE DIMENSIONS



NOTES:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25\text{mm}$ (.010") unless otherwise noted.
3. Protruded resin under flange is 1.5mm (.059") max.
4. Lead spacing is measured where the leads emerge from the package.
5. Specifications are subject to change without notice.

ABSOLUTE MAXIMUM RATINGS AT TA=25°C

PARAMETER	MAXIMUM RATING	UNIT
Power Dissipation	200	mW
Peak Forward Current (100pps, 10 μ s pulse)	2	A
Continuous Forward Current	100	mA
Reverse Voltage	5	V
Operating Temperature Range	-40°C to + 85°C	
Storage Temperature Range	-55°C to + 100°C	
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds	

ELECTRICAL / OPTICAL CHARACTERISTICS AT TA=25°C

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION
Radiant Intensity	I _E	35		75	mW/sr	I _F = 50mA
Peak Emission Wavelength	λ_P		880		nm	I _F = 50mA
Spectral Line Half-Width	$\Delta \lambda$		50		nm	I _F = 50mA
Forward Voltage	V _F	1.5	1.75	2.1	V	I _F = 350mA 100pps 10 μ s pulse
Reverse Current	I _R			100	μ A	V _R = 5V
Rise/Fall Time	T _r /T _f		40		nS	10% ~ 90%
Viewing Angle (See FIG.6)	2 $\theta_{1/2}$		16		deg.	I _F = 20mA

TYPICAL ELECTRICAL / OPTICAL CHARACTERISTICS CURVES

(25°C Ambient Temperature Unless Otherwise Noted)

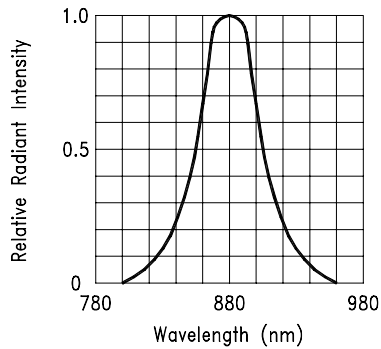


FIG.1 SPECTRAL DISTRIBUTION

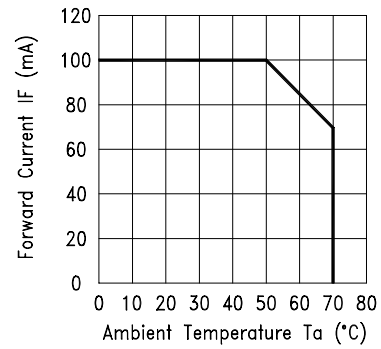


FIG.2 FORWARD CURRENT VS. AMBIENT TEMPERATURE

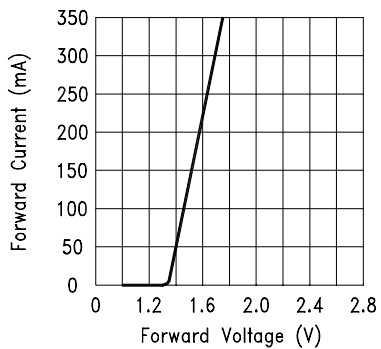


FIG.3 FORWARD CURRENT VS. FORWARD VOLTAGE

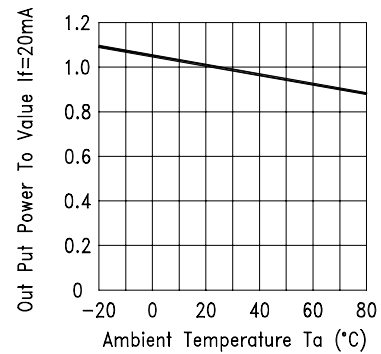


FIG.4 RELATIVE RADIANT INTENSITY VS. AMBIENT TEMPERATURE

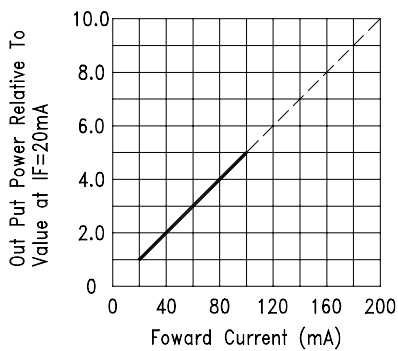


FIG.5 RELATIVE RADIANT INTENSITY VS. FORWARD CURRENT

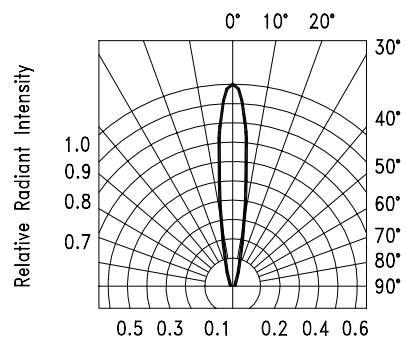
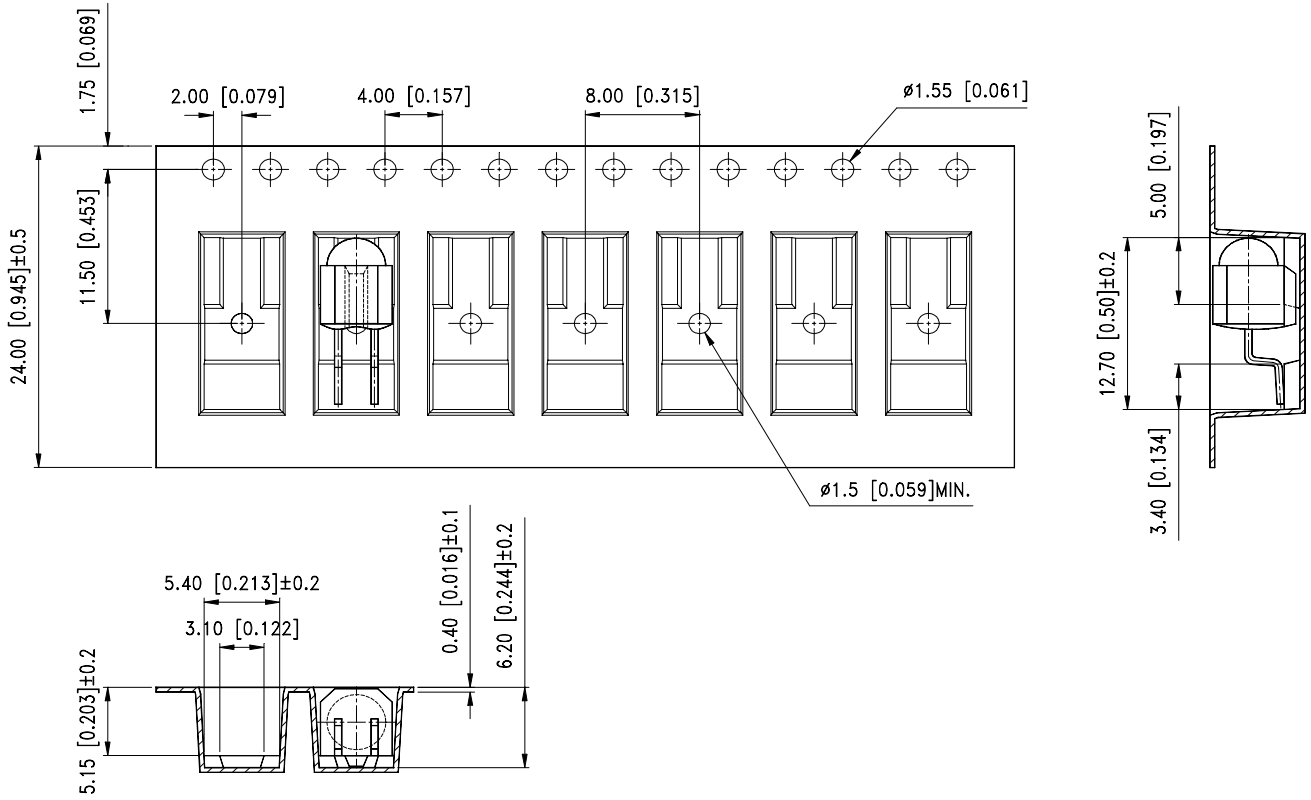


FIG.6 RADIATION DIAGRAM

Packing



Package Dimensions of Reel

